

Vishay Telefunken

# Fast Infrared Transceiver Module Family (FIR, 4 Mbit/s) for 2.6 V to 5.5 V Operation



#### **Description**

The TFDU6101E, TFDS6501E, TFDT6501E, TFDU6102E, TFDS6502E, TFDT6502E are a family of low–power infrared transceiver modules compliant to the IrDA 1.3 standard for fast infrared data communication, supporting IrDA speeds up to 4.0 Mbit/s (FIR), HP-SIR, Sharp ASK and carrier based remote control modes up to 2 MHz. Integrated within the transceiver modules are a photo PIN diode, an infrared emitter (IRED), and a low–power CMOS control IC to provide a total front–end solution in a single package.

Vishay Telefunken's FIR transceivers are available in three package options, including our Baby Face package (TFDU610xE), the standard setting, once smallest FIR transceiver available on the market. This wide selection provides flexibility for a variety of applications and space constraints. The transceivers are capable of directly interfacing with a wide variety of I/O devices which perform the modulation/ demodulation function, including National Semiconductor's PC87338, PC87108 and PC87109, SMC's FDC37C669, FDC37N769 and CAM35C44, and Hitachi's SH3. At a minimum, a current-limiting resistor in series with the infrared emitter and a V<sub>CC</sub> bypass capacitor are the only external components required implementing a complete solution.

#### **Features**

- Compliant to IrDA 1.3 (Up to 4 Mbit/s), HP–SIR<sup>®</sup>, Sharp ASK<sup>®</sup> and TV Remote Control
- For 3.0 V and 5.0 V Applications
- Operates from 2.6 V to 5.5 V within specification, operational down to 2.4 V
- Low Power Consumption (3 mA Supply Current)
- Power Shutdown Mode (1 μA Shutdown Current)
- Three Surface Mount Package Options
  - Universal  $(9.7 \times 4.7 \times 4.0 \text{ mm})$
  - Side View  $(13.0 \times 5.95 \times 5.3 \text{ mm})$
  - Top View  $(13.0 \times 7.6 \times 5.95 \text{ mm})$
- Tri-State-Receiver Output, grounded in shutdown mode for device Identification: TFDxxx01E

#### **Applications**

- Notebook Computers, Desktop PCs, Palmtop Computers (Win CE, Palm PC), PDAs
- Digital Still and Video Cameras
- Printers, Fax Machines, Photocopiers, Screen Projectors

- Tri-State-Receiver Output, floating when in shutdown mode: TFDxxx02E – versions
- High Efficiency Emitter
- Baby Face (Universal) Package Capable of Surface Mount Soldering to Side and Top View Orientation
- Directly Interfaces with Various Super I/O and Controller Devices
- Built-In EMI Protection No External Shielding Necessary
- Few External Components Required
- Backward Pin to Pin Compatible to all Vishay Telefunken SIR and FIR Infrared Transceivers
- Split power supply, transmitter and receiver can be operated from two power supplies with relaxed requirements, thus saving costs
- Telecommunication Products (Cellular Phones, Pagers)
- Internet TV Boxes, Video Conferencing Systems
- External Infrared Adapters (Dongles)
- Medical and Industrial Data Collection Devices

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## **Package Options**

TFDU6101E TFDU6102E Baby Face (Universal)







TFDT6501E TFDT6502E Top View



#### **Ordering Information**

Part Number	Qty / Reel	Description
TFDU6101E-TR3	1000 pcs	Oriented in carrier tape for side view surface mounting
TFDU6101E-TT3	1000 pcs	Oriented in carrier tape for top view surface mounting
TFDS6501E-TR3	750 pcs	Side View
TFDT6501E-TR3	750 pcs	Top View
TFDU6102E-TR3	1000 pcs	Oriented in carrier tape for side view surface mounting
TFDU6102E-TT3	1000 pcs	Oriented in carrier tape for top view surface mounting
TFDS6502E-TR3	750 pcs	Side View
TFDT6502E-TR3	750 pcs	Top View

## **Functional Block Diagram**

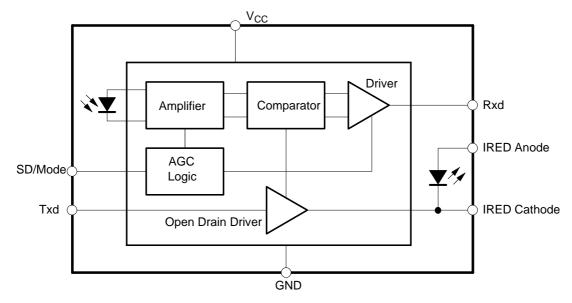


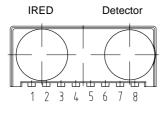
Figure 1. Functional Block Diagram

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## **Pin Description**

Pin Number		Function	Description	I/O	Active
"U" and "T" Option	"S" Option				
1	8	IRED Anode	IRED anode, to be externally connected to $V_{CC}$ through a current control resistor. This pin is allowed to be supplied from an uncontrolled power supply separated from the controlled $V_{CC}$ supply		
2	1	IRED Cathode	IRED cathode, internally connected to driver transistor		
3	7	Txd	Transmit Data Input	I	HIGH
4	2	Rxd	TFDxxx01E: Received Data Output, push-pull CMOS driver output capable of driving a standard CMOS or TTL load. No external pull-up or pull-down resistor is required. Pin is switched to ground when device is in shutdown mode  TFDxxx02E: Received Data Output, push-pull CMOS driver output capable of driving a standard CMOS or TTL load. No external pull-up or pull-down resistor is required. Pin is floating when device is in shutdown mode	0	LOW
5	6	SD/Mode	Shutdown/ Mode	I	HIGH
6	3	V <sub>CC</sub>	Supply Voltage		
7	5	Mode	HIGH: High speed mode; LOW: Low speed mode, SIR only (see chapter "Mode Switching")	I	
8	4	GND	Ground		

#### "U" Option BabyFace (Universal)



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#### "S" Option Side View

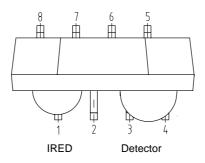
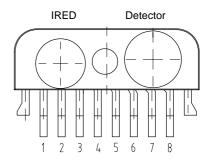


Figure 2. Pinnings

#### "T" Option Top View



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## **Absolute Maximum Ratings**

Reference point Pin: GND unless otherwise noted.

Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage Range, Transceiver	0 V <v<sub>CC2 &lt;6 V</v<sub>	V <sub>CC1</sub>	- 0.5		6	V
Supply Voltage Range, Transmitter	0 V <v<sub>CC1 &lt;6 V</v<sub>	V <sub>CC2</sub>	- 0.5		6	V
Input Currents	For all Pins, Except IRED Anode Pin				10	mA
Output Sinking Current					25	mA
Power Dissipation	See Derating Curve	P <sub>D</sub>			350	mW
Junction Temperature		$T_J$			125	°C
Ambient Temperature Range (Operating)		T <sub>amb</sub>	-25		+85	°C
Storage Temperature Range		T <sub>stg</sub>	-25		+85	°C
Soldering Temperature	See Recommended Solder Profile (see Figure 9)				240	°C
Average Output Current		I <sub>IRED</sub> (DC)			130	mA
Repetitive Pulsed Output Current	<90 μs, t <sub>on</sub> <20%	I <sub>IRED</sub> (RP)			600	mA
IRED Anode Voltage		V <sub>IREDA</sub>	- 0.5		6	V
Transmitter Data Input Voltage		V <sub>Txd</sub>	- 0.5		V <sub>CC1</sub> +0.5	V
Receiver Data Output Voltage		V <sub>Rxd</sub>	- 0.5		V <sub>CC1</sub> +0.5	V
Virtual Source Size	Method: (1–1/e) encircled energy	d	2.5	2.8		mm
Maximum Intensity for Class 1 Operation of IEC825–1 or EN60825–1 (worst case IrDA FIR pulse pattern)	EN60825, 1997, unidirectional operation, worst case test mode				320	mW/sr



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#### **Electrical Characteristics**

 $T_{amb}$  = 25°C,  $V_{CC}$  = 2.6V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

Parameters	Test Conditions / Pins	Symbol	Min.	Тур.	Max.	Unit	
Transceiver							
Supply Voltage		V <sub>CC</sub>	2.6		5.5	V	
Dynamic Supply Current	Receive mode only. In transmit mode, add additional 85 mA (typ) for IRED current						
	$SD = Low, E_e = 0 klx$	I <sub>CC</sub>		3	4	mA	
	$SD = Low, E_e = 1 klx *)$	I <sub>CC</sub>		3	4	mA	
Standby Supply Current	SD = High, Mode = Floating, T = $25^{\circ}$ C, E <sub>e</sub> = 0 klx	I <sub>SD</sub>			1	μА	
	T = 25°C, E <sub>e</sub> = 1 klx *)  SD = High, T = 85°C,  Mode = Floating,  Not Ambient Light Sensitive	I <sub>SD</sub>			1.5 5	μΑ μΑ	
Operating Temperature Range		T <sub>A</sub>	-25		+85	°C	
Output Voltage Low	$R_{load} = 2.2 \text{ k}\Omega,$ $C_{load} = 15 \text{ pF}$	V <sub>OL</sub>		0.5	0.8	V	
Output Voltage High	$R_{load} = 2.2 \text{ k}\Omega,$ $C_{load} = 15 \text{ pF}$	V <sub>OH</sub>	V <sub>CC</sub> -0.5			V	
Input Voltage Low (Txd, SD/ Mode, Mode)		V <sub>IL</sub>	0		0.8	V	
Input Voltage High	CMOS level **)	V <sub>IH</sub>	0.9 x V <sub>CC</sub>			V	
(Txd, SD/ Mode, Mode)	TTL level, V <sub>CC</sub> ≥ 4.5 V	V <sub>IH</sub>	2.4			V	
Input Leakage Current (Txd, SD/ Mode)		ΙL	-10		+10	μΑ	
Input Leakage Current, Mode		ΙL	-80		+80	μΑ	
Input Capacitance		C <sub>I</sub>			5	pF	

<sup>\*)</sup> Standard Illuminant A

<sup>\*\*)</sup> The typical threshold level is between 0.5 x  $V_{CC/2}$  ( $V_{CC}$  = 3 V) and 0.4 x  $V_{CC}$  ( $V_{CC}$  = 5.5 V) . It is recommended to use the specified min/ max values to avoid increased operating current.

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## **Optoelectronic Characteristics**

 $T_{amb}$  = 25°C,  $V_{CC}$  = 2.6 V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Receiver						
Minimum Detection Threshold Irradiance, SIR Mode	TFDS6501E/ TFDT6501E 9.6 kbit/s to 115.2 kbit/s λ = 850 nm to 900 nm	E <sub>e</sub>		20	35	mW/m <sup>2</sup>
	TFDU6101E 9.6 kbit/s to 115.2 kbit/s $\lambda$ = 850 nm to 900 nm	E <sub>e</sub>		25	40	mW/m <sup>2</sup>
Minimum Detection Threshold Irradiance, MIR Mode	TFDS6501E/ TFDT6501E 1.152 Mbit/s λ = 850 nm to 900 nm	E <sub>e</sub>		50		mW/m <sup>2</sup>
	TFDU6101E 1.152 Mbit/s λ = 850 nm to 900 nm	E <sub>e</sub>		65		mW/m <sup>2</sup>
Minimum Detection Threshold Irradiance, FIR Mode	TFDS6501E/ TFDT6501E 4.0 Mbit/s λ = 850 nm to 900 nm	E <sub>e</sub>		65	100	mW/m <sup>2</sup>
	TFDU6101E 4.0 Mbit/s λ = 850 nm to 900 nm	E <sub>e</sub>		85	100	mW/m <sup>2</sup>
Maximum Detection Threshold Irradiance	$\lambda = 850 \text{ nm to } 900 \text{ nm}$	E <sub>e</sub>	5	10		kW/m <sup>2</sup>
Logic LOW Receiver Input Irradiance		E <sub>e</sub>	4			mW/m <sup>2</sup>
Rise Time of Output Signal—,,,,klll	10% to 90%, @2.2 kΩ, 15 pF	t <sub>r (Rxd)</sub>	10		40	ns
Fall Time of Output Signal	90% to 10%, @2.2 kΩ, 15 pF	t <sub>f (Rxd)</sub>	10		40	ns
Rxd Pulse Width of	Input pulse length 20 μs, 9.6 kbit/s	t <sub>PW</sub>	1.2	10	20	μs
Output Signal, 50% SIR Mode	Input pulse length 1.41 μs, 115.2 kbit/s	t <sub>PW</sub>	1.2		1/2 bit length	μs
Rxd Pulse Width of Output Signal, 50% MIR Mode	Input pulse length 217 ns, 1.152 Mbit/s	t <sub>PW</sub>	110		260	ns
Jitter, Leading Edge, MIR Mode	Input Irradiance = 100 mW/m <sup>2</sup> , 1.152 Mbit/s				10	ns
Rxd Pulse Width of Output Signal, 50% FIR Mode	Input pulse length 125 ns, 4.0 Mbit/s	t <sub>PW</sub>	100		160	ns
	Input pulse length 250 ns, 4.0 Mbit/s	t <sub>PW</sub>	200		290	ns
Jitter, Leading Edge, FIR Mode	Input Irradiance = 100 mW/m <sup>2</sup> , 4.0 Mbit/s				10	ns
Latency		t∟			120	μs



Vishay Telefunken

## **Optoelectronic Characteristics (continued)**

 $T_{amb}$  = 25°C,  $V_{CC}$  = 2.6 V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

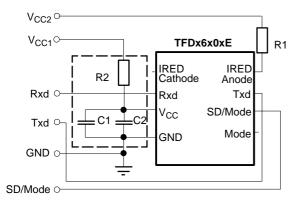
Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Transmitter						
IRED Operating Current	$R1*) = 7.2 \Omega, V_{CC} = 5.0 V$	I <sub>D</sub>		0.4	0.55	Α
Output Radiant Intensity (see Figure 3)	$V_{CC}$ = 5.0 V, $\alpha$ = 0°, 15° Txd = High, SD = Low, R1 = 7.2 $\Omega$	l <sub>e</sub>	120	170	350	mW/sr
Output Radiant Intensity	$V_{CC}$ = 5.0 V, $\alpha$ = 0°, 15° Txd = Low, SD = High, (Receiver is inactive as long as SD = High) R1 = 7.2 $\Omega$	l <sub>e</sub>			0.04	mW/sr
Output Radiant Intensity, Angle of Half Intensity		α		±24		°C
Peak – Emission Wavelength		$\lambda_{ m P}$	880		900	nm
Optical Rise Time, Fall Time		t <sub>ropt</sub> , t <sub>fopt</sub>	10		40	ns
Optical Overshoot					10	%

<sup>\*)</sup> R1: control series resistor for current limitation

#### Vishay Telefunken



The only required component for designing an IrDA 1.3 solution using Vishay Telefunken transceivers is a current limiting resistor, R1, to the IRED. However, depending on the entire system design and board layout, additional components may be required (see figure 3).



Note: Outlined components are optional depending on the quality of the power supply.

Figure 3. Recommended Application Circuit

Vishay Telefunken transceivers integrate a sensitive receiver and a built-in power driver. The combination of both needs a careful circuit board layout. The use of thin, long, resistive and inductive wiring should be avoided. The inputs (Txd, SD/ Mode) and the output Rxd should be directly (DC) coupled to the I/O circuit.

R1 is used for controlling the current through the IR emitter. For increasing the output power of the IRED, the value of the resistor should be reduced. Similarly, to reduce the output power of the IRED, the value of the resistor should be increased. For typical values of R1 see figure 4. For IrDA compliant operation, a current control resistor of 7.2  $\Omega$  is recommended. For compensating losses of the cosmetic window, reducing that value to 5.6  $\Omega$  is acceptable. The upper drive current limitation is dependent on the duty cycle and is given by the absolute maximum ratings on the data sheet.

R2, C1 and C2 are optional and dependent on the quality of the supply voltage  $V_{CC}$  and injected noise. An unstable power supply with dropping voltage during transmission may reduce sensitivity (and transmission range) of the transceiver.

The placement of these parts is critical. It is strongly recommended to position C2 as near as possible to the transceiver power supply pins. An electrolytic capacitor should be used for C1 while a ceramic capacitor is used for C2.

Table 1. Recommended Application Circuit Components

Component	Recommended Value	Vishay Part Number
C1	4.7 μF, Tantalum	293D 475X9 016B 2T
C2	0.1 μF, Ceramic	VJ 1206 Y 104 J XXMT
R1	5 V supply voltage: 7.2 $\Omega$ , 0.25 W (recommend using two 3.6 $\Omega$ , 0.125 W resistors in series) 3.3 V supply voltage: 3.6 $\Omega$ , 0.25 W (recommend using two 1.8 $\Omega$ , 0.125 W resistors in series)	CRCW-1206-3R60-F-RT1  CRCW-1206-1R80-F-RT1
R2	$47~\Omega$ , 0.125 W	CRCW-1206-47R0-F-RT1





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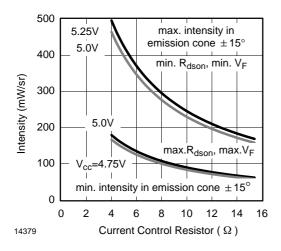


Figure 4. Intensity I<sub>e</sub> vs. Current Control Resistor R1, 5 V Applications

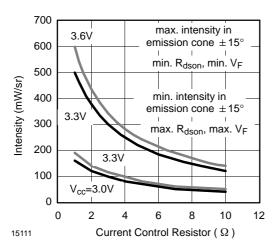


Figure 5. Intensity  $I_e$  vs. Current Control Resistor R1, 3 V Applications

In addition, when connecting the described circuit to the power supply, low impedance wiring should be used.

#### I/O and Software

In the description, already different I/Os are mentioned. Differnt combinations are tested and the function verified with the special drivers available from the I/O suppliers. In special cases refer to the I/O manual, the Vishay application notes, or contact directly Vishay Sales, Marketing or Application.

#### Control: Differences to TFDx6000 Series

For applications using I/Os from NSC, Winbond and TI no software upgrade is necessary. In combination with the latest SMSC controllers for Microsoft Windows 98® a software upgrade is necessary, drivers

are available from SMSC and Vishay Semiconductor GmbH. This software is intended to work with Windows 95<sup>®</sup>, too. Alternatively the HP/ Sharp settings can be selected. The Microsoft Operating Systems NT 5.0<sup>®</sup> Beta 2 and Windows 2000<sup>®</sup> provide Miniport device drivers.

#### **Mode Switching**

The TFDU610xE, TFDS650xE and TFDT650xE do not power on with a default mode, therefore the data transfer rate has to be set by a programming sequence using the Txd and SD/ Mode inputs as described below or selected by setting the Mode Pin. The Mode Pin can be used to statically set the mode (Mode Pin: LOW: SIR, HIGH: 0.576 Mbit/s to 4.0 Mbit/s). When using the Mode Pin, the standby current may increase to about 50 to 60 µA when high or low. If not used or in standby mode, the mode input should float to minimize standby current. The low frequency mode covers speeds up to 115.2 kbit/s. Signals with higher data rates should be detected in the high frequency mode. Lower frequency data can also be received in the high frequency mode but with reduced sensitivity. To switch the transceivers from low frequency mode to the high frequency mode and vice versa, the programming sequences described below are required.

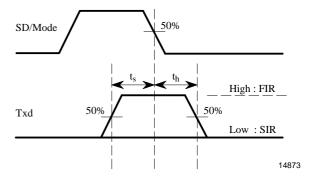


Figure 6. Mode Switching Timing Diagram

## Setting to the High Bandwidth Mode (0.576 Mbit/s to 4.0 Mbit/s)

- 1. Set SD/MODE input to logic "HIGH".
- 2. Set Txd input to logic "HIGH". Wait  $t_s \ge 200$  ns.
- Set SD/MODE to logic "LOW" (this negative edge latches state of Txd, which determines speed setting).
- After waiting t<sub>h</sub> ≥ 200 ns Txd can be set to logic "LOW". The hold time of Txd is limited by the maximum allowed pulse length.

Txd is now enabled as normal Txd input for the high bandwidth mode.

#### Vishay Telefunken

# VISHAY

## Setting to the Lower Bandwidth Mode (2.4 kbit/s to 115.2 kbit/s)

- 1. Set SD/MODE input to logic "HIGH".
- 2. Set Txd input to logic "LOW". Wait  $t_s \ge 200$  ns.
- Set SD/MODE to logic "LOW" (this negative edge latches state of Txd, which determines speed setting).
- 4. Txd must be held for  $t_h \ge 200$  ns.

Txd is now enabled as normal Txd input for the lower bandwidth mode.

#### **Recommended SMD Pad Layout**

The leads of the device should be soldered in the center position of the pads.

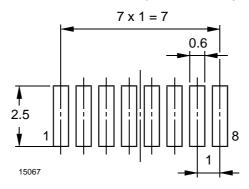


Figure 7. TFDU6101E/ TFDU6102E BabyFace (Universal)

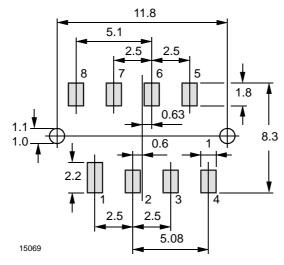


Figure 8. TFDS6501E/TFDS6502E Side View Package Pad 1 is longer to designate Pin 1 connection to transceiver.



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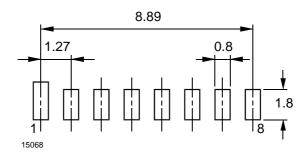


Figure 9. TFDT6501E/ TFDT6502E Top View Package Pad 1 is longer to designate Pin 1 connection to transceiver.

Note: Leads of the device should be at least 0.3 mm within the ends of the pads.

#### **Recommended Solder Profile**

#### 240 210 180 Temperature (°C) 150 120 120 - 180 s 90 60 30 0 0 50 100 150 200 250 300 350 14874 Time (s)

Figure 10. Recommended Solder Profile

#### **Current Derating Diagram**

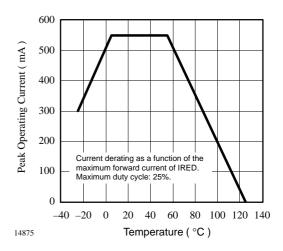
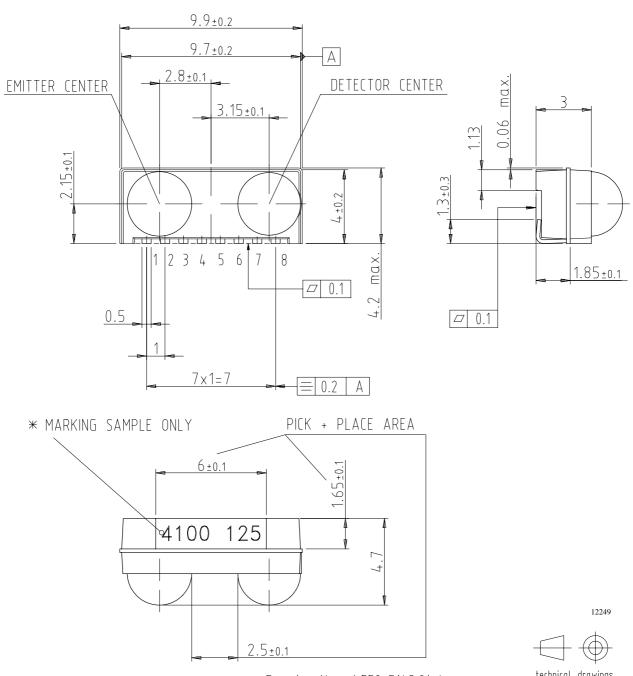


Figure 11. Current Derating Diagram

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### TFDU6101E/ TFDU6102E - Baby Face (Universal) Package (Mechanical Dimensions)



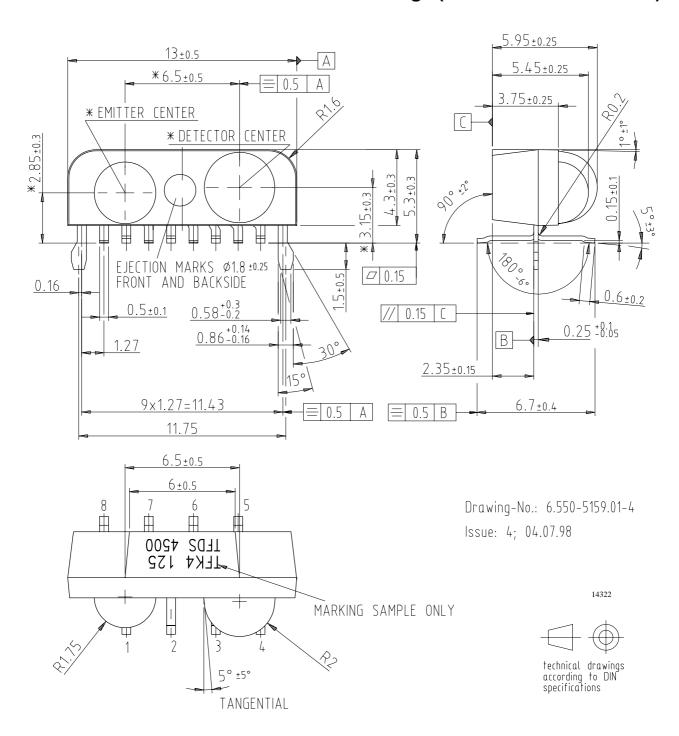
\* MARKING ORIENTATION 180 DEGREES ALLOWED Drawing-No.: 6.550-5148.01-4

Issue: 8; 10.7.98



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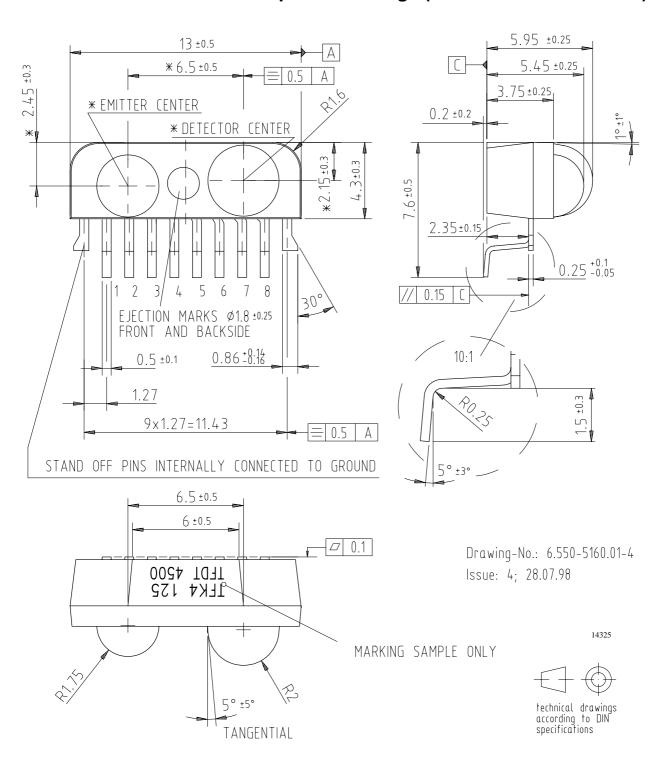
#### TFDS6501E/ TFDS6502E - Side View Package (Mechanical Dimensions)



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#### **TFDT6501E/ TFDT6502E – Top View Package (Mechanical Dimensions)**





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#### **Revision History:**

B1.1, 01/03/1999: New edition for optimized E family. TFDxxx01E - RXD output is grounded when the device

is switched to shutdown mode.

B1.2, 15/03/1999: A clean tri-state version with floating output in shutdown mode was added as 02 version. The

output radiant intensity was increased.

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#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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